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# Determination of the graphene growth mode on SiC(0001) and SiC(000 $\bar{1}$ )

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We have determined the growth mode of graphene on SiC(0001) and SiC(000 $\bar{1}$ ) using ultra-thin, isotopically-labeled Si<sup>13</sup>C ‘marker layers’ grown epitaxially on the Si<sup>12</sup>C surfaces. Few-layer graphene overlayers were formed via thermal decomposition at elevated temperature. For both surface terminations (Si-face and C-face), we find that the <sup>13</sup>C is located mainly in the outermost graphene layers, indicating that, during decomposition, new graphene layers form underneath existing ones.

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Graphene has attracted considerable attention, in part, due to potential applications in electronics [1–3]. Several techniques have been employed to synthesize graphene: mechanical exfoliation, chemical vapor deposition onto metal surfaces, and sublimation of Si from SiC. This latter technique is attractive for electronics applications because the graphene is formed directly on an insulating substrate, although many aspects of the formation process are poorly understood. Graphene has been grown via decomposition on several polytypes of SiC. Attention has mainly focussed on the (0001) and (000 $\bar{1}$ ) surfaces of the 4H and 6H polytypes. These polytypes correspond to different stacking sequences of hexagonal SiC bilayers. Within the bilayers, Si and C atoms are not co-planar. At the (0001) surface, the Si atoms are outermost, while at the (000 $\bar{1}$ ) surface, the C atoms are outermost.

Perhaps surprisingly, the growth of graphene on these two surfaces is significantly different. On SiC(0001), graphene layers are epitaxial, forming a well-ordered  $6\sqrt{3} \times 6\sqrt{3}$  superstructure [4]. Even thick graphene films exhibit an epitaxial relationship to the underlying substrate. In contrast, graphene grown on SiC(000 $\bar{1}$ ) is more randomly oriented, indicating a much weaker substrate influence [5, 6].

These differences in graphene crystallography suggest that the growth mode of graphene might be very different on these surfaces. On SiC(0001), the observed epitaxy has led to speculation that graphene grows “from the inside out” [7]. That is, strong coupling to the substrate induces epitaxy in the first graphene layer. The second graphene layer forms *under* the first, and is oriented due to coupling to the SiC. The second layer displaces the first layer outward. This process continues as the film grows thicker, resulting in a crystalline film in which the outmost layer is the first layer to form. The more-random stacking of graphene on SiC(000 $\bar{1}$ ) makes it difficult to infer the growth mode, but might indicate that it is substantially different from SiC(0001).

Here, we use isotopic labeling to directly measure the graphene growth mode on both SiC(0001) and SiC(000 $\bar{1}$ ). We grew thin epitaxial SiC films via chemical vapor deposition using a mixture of disilane and isotopically pure

<sup>13</sup>C ethylene. The thickness of the epitaxial layers was 4–5 bilayers, so that the carbon content was slightly more than that of a single graphene layer. We then formed graphene via SiC decomposition at elevated temperature [4, 8]. After graphene formation we used medium-energy ion scattering (MEIS) [9] to measure the depth distributions of both <sup>12</sup>C and <sup>13</sup>C. If graphene grows from the inside out <sup>13</sup>C will be located predominantly at the surface. Conversely, if new graphene layers form on top of existing ones, <sup>13</sup>C will be situated underneath a <sup>12</sup>C overlayer. We found that for graphene grown on both SiC(0001) and SiC(000 $\bar{1}$ ), <sup>13</sup>C remains largely at the surface, showing directly that new graphene layers form under existing layers. Our approach is similar to that used by Gusev *et al.* to study the oxidation of Si(001) using <sup>16</sup>O<sub>2</sub> and <sup>18</sup>O<sub>2</sub> [10].

SiC(0001)-6H and (000 $\bar{1}$ )-6H surfaces were prepared by annealing in a disilane background, as describe elsewhere [11, 12]. This method leads to the formation of a uniform, reproducible surface that consists of terraces bounded by straight steps with a uniform step height of  $\sim 0.8$  nm (Fig. 1). This step height corresponds to three SiC bilayers.

Isotopically-labeled, epitaxial SiC layers were then grown by exposing the clean surface to a mixture of disilane (Si<sub>2</sub>H<sub>6</sub>) and isotopically-pure ethylene (<sup>13</sup>C<sub>2</sub>H<sub>4</sub>). In this way, SiC bilayers containing <sup>13</sup>C, i.e. Si<sup>13</sup>C, were grown on top of the Si<sup>12</sup>C substrate. Prior to ethylene exposure, the substrate temperature was raised to 1200 °C in  $5 \times 10^{-6}$  Torr disilane. The growth of Si<sup>13</sup>C was initiated by adding <sup>13</sup>C<sub>2</sub>H<sub>4</sub> to the disilane until a total pressure of  $7 \times 10^{-6}$  Torr was achieved. The growth of epitaxial layers was monitored *in situ* using LEEM. Under these growth conditions, and for terrace widths of a few 100 nm, Si<sup>13</sup>C grows via step-flow, with three bilayers advancing simultaneously. That is, the step height of 0.76 nm is maintained. During growth, steps advanced at a constant rate, and the nucleation of new SiC layers (e.g. islands) was not observed. LEEM images recorded before and after Si<sup>13</sup>C growth are shown in Fig. 1c. The positions of selected steps are marked before and after growth, indicating that slightly more than three bilayers

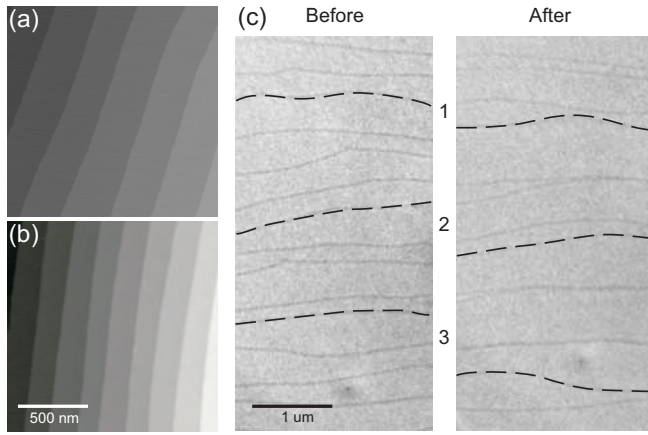


FIG. 1. AFM images recorded after annealing (a) SiC(0001)-6H, and (b) SiC(000 $\bar{1}$ )-6H, at 1200 °C in  $10^{-6}$  Torr disilane. A uniform step height of 0.8 nm is observed at both surfaces, corresponding to three SiC bilayers. (c) Drift corrected 47 eV bright-field LEEM images recorded before and after CVD growth of Si $^{13}$ C. The initial and final positions of selected steps are shown, indicating downward step flow during growth.

of SiC were grown.

The measured step velocity corresponded to a growth rate of approximately one SiC bilayer per minute. After the growth of about three SiC bilayers, the ethylene flow was stopped, but the disilane background pressure was maintained in order to prevent graphene formation. When the ethylene was removed, the step motion ceased. The structure of the resulting surface is shown schematically in Fig. 2a. The structure shown in Fig. 2a corresponds to three Si $^{13}$ C bilayers grown on bulk Si $^{12}$ C. When annealed above the Si sublimation temperature, graphene will form. The 6H polytype decomposes in units of three bilayers [13], and the carbon density in graphene is equal to that of three bilayers. Therefore, the structure shown in Fig. 2b – a pure  $^{13}$ C graphene layer on bulk Si $^{12}$ C – should result if the decomposition is halted after the formation of a single graphene layer. This ‘marker’ layer can be used to determine where additional graphene layers form, giving insight into the kinetics of graphene formation. For example, if additional graphene layers form under pre-existing layers (Fig. 2c), the  $^{13}$ C layer will always be outermost. Conversely, if additional layers form on top of pre-existing graphene, the  $^{13}$ C layer will be located at the graphene/SiC interface, underneath a  $^{12}$ C graphene overlayer (Fig. 2d).

MEIS can be used to distinguish between these two possible growth modes. In our MEIS experiments, a 100 keV proton beam was incident normal to the surface and the kinetic energy of the backscattered protons was measured over a range of scattering angles near 110°. The energy of the backscattered protons can be used to determine the depth distribution and mass of the near-

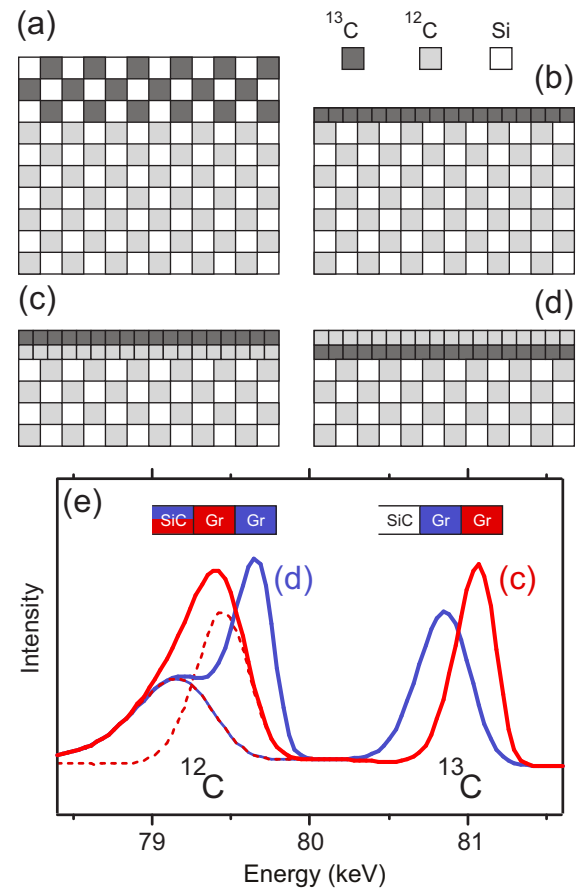


FIG. 2. (a) Three epitaxial Si $^{13}$ C bilayers grown on bulk Si $^{12}$ C. (b) Resulting  $^{13}$ C graphene layer that forms upon thermal decomposition of the outer three bilayers. (c,d) Two possible structures for bilayer graphene formed upon further thermal decomposition. (e) Simulated 100 keV MEIS energy spectra for the structures shown in (c). The curves show simulations for  $^{13}$ C on top (red) and  $^{12}$ C on top (blue). When  $^{13}$ C is on top, the  $^{12}$ C peak is shifted to lower energy. Conversely, when  $^{12}$ C is on top, the  $^{13}$ C peak is shifted to lower energy. Dashed lines indicate the deconvolution of the  $^{12}$ C spectrum into SiC and interfacial graphene components.

surface atoms. Two basic processes determine the final proton energy. First, when a proton scatters elastically from a nucleus, conservation of energy and momentum leads to a characteristic backscatter energy given by the mass of the target nucleus and the scattering angle. This dependence can be used to measure the absolute concentrations of  $^{12}$ C and  $^{13}$ C. Each isotope gives rise to a characteristic peak in the proton energy spectrum. Second, as the proton travels through the sample, inelastic electronic interactions give rise to a characteristic energy loss per unit length travelled. For most materials, the maximum energy loss per unit length (for protons) occurs near 100 keV, which makes MEIS particularly surface sensitive. Protons that scatter from nuclei located below the surface will have a lower kinetic energy than

those that scatter from nuclei at the surface. The depth distribution will give a characteristic shape and width to the peak in the proton energy spectrum. These features of MEIS make it possible to measure accurate depth profiles for both  $^{12}\text{C}$  and  $^{13}\text{C}$  [14].

In Fig. 2e the calculated energy distribution of scattered protons is shown for the structures indicated in Fig. 2c,d. The simulation is for an incident energy of 100 keV, with a total instrumental resolution of 150 eV, and a scattering angle of  $110^\circ$ . Both distributions have two clear peaks, associated with the two carbon isotopes. The proton energy is higher for scattering from  $^{13}\text{C}$  than for  $^{12}\text{C}$  simply because the target nucleus is heavier. The  $^{13}\text{C}$  peak for model (d) is lower in energy than that for model (c), reflecting the fact that the  $^{13}\text{C}$  graphene layer in (d) is underneath a  $^{12}\text{C}$  overlayer. In addition, the  $^{12}\text{C}$  peak for model (d) has two components. The larger peak, close to 80 keV, is due to scattering from the  $^{12}\text{C}$  graphene layer at the surface, while the broader peak at lower energy is due scattering from carbon in SiC.

LEEM imaging during  $\text{Si}^{13}\text{C}$  epitaxy shows that the structure depicted in Fig. 2a can be grown on both  $\text{SiC}(0001)$  and  $\text{SiC}(000\bar{1})$ . After epi-layer growth, a single graphene layer (Fig. 2b) was formed by raising the temperature to  $1270^\circ\text{C}$  and slowly reducing the background pressure of disilane while the surface was imaged [12]. Upon formation of a complete layer, the sample temperature was quickly reduced to prevent further decomposition. After graphene formation, the samples were transferred (through air) to the MEIS system.

Selected MEIS data from graphene layers grown on both  $\text{SiC}(0001)$  and  $\text{SiC}(000\bar{1})$  are shown in Fig. 3. The filled symbols in Fig. 3a correspond to a sample with 1.3 ML of graphene. The surface stoichiometry is determined by simulating the MEIS spectrum for a trial structure and adjusting the model parameters to maximize the agreement between the simulation and the experiment. The trial structure consists of a sequence of homogeneous layers, specifically one or two carbon layers on top of a SiC layer, each with specific density, thickness, and stoichiometry [15]. In order to minimize the number of free parameters, for the thicker graphene films we adopted a minimal model in which the graphene film is divided into two regions: an ‘outer’ region in contact with the vacuum and an ‘inner’ region in contact with the substrate. The relative fraction of  $^{13}\text{C}$  in each region is a free parameter, as well as the thickness. A convenient parameterization of the  $^{13}\text{C}$  content is given by  $F = N_{13}/(N_{12} + N_{13})$ , where  $N_{12}$  and  $N_{13}$  are the numbers of  $^{12}\text{C}$  and  $^{13}\text{C}$  atoms in the region of interest. For single-layer graphene only one region is considered, and we find  $F = 0.80$ , indicating small but significant intermixing during decomposition at  $1270^\circ\text{C}$ . Most likely,  $^{12}\text{C}$  is incorporated in the graphene due to the formation of pits during the decomposition [13]. Pits expose the underlying SiC, which can then decompose and con-

tribute  $^{12}\text{C}$  to the graphene layer. The presence of some  $^{12}\text{C}$  in the graphene layer can also result from imperfect ‘reverse’ step flow during decomposition. If the final step structure is not identical to the structure before  $\text{Si}^{13}\text{C}$  growth (e.g. Fig. 1c), some  $\text{Si}^{13}\text{C}$  will remain intact and some  $\text{Si}^{12}\text{C}$  will decompose. Thicker graphene

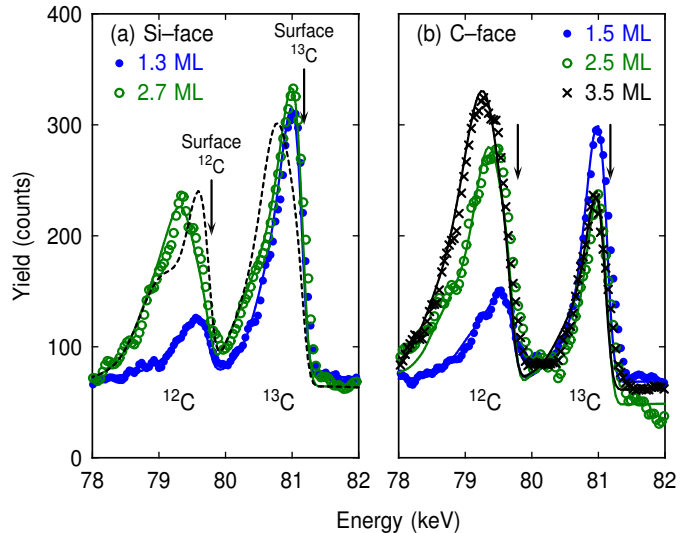


FIG. 3. 100 keV MEIS energy distributions recorded for graphene grown on (a)  $\text{SiC}(0001)$  and (b)  $\text{SiC}(000\bar{1})$ . Symbols are measured data, and curves are simulation results. The color indicates the average graphene thickness. Blue, green, and black correspond to approximately 1.5, 2.5, and 3.5 ML of graphene respectively. Arrows indicate the energy of protons scattered from  $^{12}\text{C}$  and  $^{13}\text{C}$  situated at the surface. The black dashed curve in (a) indicates a model for 2.7 ML of graphene in which the  $^{13}\text{C}$  graphene is located under the  $^{12}\text{C}$  graphene rather than above it (see text).

films were produced using a two-step process. First,  $^{13}\text{C}$ -rich graphene monolayers were formed using the method described above: growth of about three bilayers of epitaxial  $\text{Si}^{13}\text{C}$  at  $1200^\circ\text{C}$  followed by controlled decomposition at  $1270^\circ\text{C}$  to form the initial graphene layer. Next, additional graphene layers were formed by annealing for 3' at  $1450^\circ\text{C}$ . MEIS analysis of these films shows that the graphene film is indeed thicker. For example, for the film shown in (Fig. 3a, open symbols), the graphene thickness was 2.7 layers (with the equivalent of 1.7 layers of  $^{13}\text{C}$  and 1.0 layer of  $^{12}\text{C}$ ). The qualitative result is clear in the raw data shown in Fig. 3a. Compared to the 1.3 ML film, the  $^{12}\text{C}$  peak for the 2.7 ML film is larger, and the centroid is shifted to lower energy. The shift to lower energy indicates that the bulk of the  $^{12}\text{C}$  graphene is located further from the surface. The  $^{13}\text{C}$  peak has roughly the same intensity and is not shifted in energy. These observations suggest that the thicker film contains more  $^{12}\text{C}$  graphene, but that the additional graphene is located below the surface. Quantitative analysis using the two-region model supports this conclusion: the top

half of the film is  $^{13}\text{C}$ -rich ( $F = 0.80$ ) while the lower half is  $^{12}\text{C}$ -rich ( $F = 0.43$ ). This direct measurement shows that the growth mode of graphene on SiC(0001) corresponds to Fig. 2c. New graphene layers form underneath pre-existing layers, as proposed by Emtsev *et al.* [7]. In addition, the MEIS analysis shows that there is very little bulk C diffusion during the brief (minutes) annealing at 1450 °C. Finally, the black dashed line in Fig. 3a shows the simulated spectrum for a graphene film with an *inverted* isotope depth distribution:  $^{12}\text{C}$ -rich in the top half ( $F = 0.43$ ) and  $^{13}\text{C}$ -rich in the lower half ( $F = 0.80$ ). The disagreement with the measured data is striking, indicating the sensitivity of the MEIS analysis to the isotopic composition.

In contrast to SiC(0001), graphene grown on the SiC(000 $\bar{1}$ ) is not locked azimuthally to the substrate. The domain size measured in our experiments is generally smaller, and both the graphene growth rate and nucleation rate are significantly higher than on SiC(0001). We performed MEIS experiments in order to determine if the growth mode is fundamentally different from that measured for SiC(0001).

Graphene layers of varying thickness were formed on SiC(000 $\bar{1}$ ) using a similar procedure to that described above for SiC(0001). The only significant difference was that, due to the higher growth rate on SiC(000 $\bar{1}$ ), thicker graphene films were formed at 1325 °C rather than 1450 °C. The MEIS analysis of 1.5, 2.5 and 3.5 ML films is shown in Fig. 3b. In all cases, the thickness of the epitaxial Si $^{13}\text{C}$  layer initially grown corresponded to about 1.4 ML of graphene. For the 1.5 ML film, 3/4 of the  $^{13}\text{C}$  remained in the graphene layer ( $F = 0.76$ ), indicating that the intermixing during the initial graphene formation is similar to what was observed for SiC(0001). For the thicker films, several qualitative observations can be made. First, the area of the  $^{12}\text{C}$  peak clearly increases with annealing time, indicating a thicker graphene film. Conversely, the area of the  $^{13}\text{C}$  is essentially constant (within the sample-to-sample variation in the Si $^{13}\text{C}$  thickness). Furthermore, the  $^{13}\text{C}$  peak does not shift to lower energy, indicating that, in all cases, the  $^{13}\text{C}$  graphene is located mainly at the surface. Quantitative modeling using the two-region model confirms this view. For the 2.5 ML film,  $F = 0.61$  in the top half of the film, while in the lower half,  $F = 0.17$ . Clearly most of the  $^{13}\text{C}$  remains at the surface. For the 3.5 ML the results are similar:  $F = 0.61$  in the top third of the film, while  $F = 0.20$  in the bottom 2/3 of the graphene film. Taken together, these results show that when SiC(000 $\bar{1}$ ) is annealed at 1325 °C, additional graphene layers form underneath the initial ( $^{13}\text{C}$ -rich) graphene layer formed at 1200 °C. That is, the graphene growth mode is essentially the same on SiC(0001) and SiC(000 $\bar{1}$ ), despite

the stark contrast in the crystal quality of the graphene layers on SiC(0001) and SiC(000 $\bar{1}$ ).

In summary, we have directly measured the growth mode of graphene on SiC(0001) and SiC(000 $\bar{1}$ ) during SiC decomposition at high-temperature. Ultra-thin Si $^{13}\text{C}$  epitaxial ‘marker layers’ were grown on both surfaces. Following graphene formation, MEIS was used to measure the depth distribution of  $^{13}\text{C}$  and  $^{12}\text{C}$ . At both surfaces (Si-face and C-face), we find that  $^{13}\text{C}$  is located primarily in the outmost graphene layers. That is, despite very different graphene crystallography on the (0001) and (000 $\bar{1}$ ) surfaces, the graphene growth mode is the same: new graphene layers form underneath existing ones.

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